

High power density building blocks ideal for on-board power-distribution schemes in which isolated 12V buses deliver power to any number of non-isolated, step-down buck regulators.

# **FEATURES**

- Step-down buck regulators for new distributed 12V power architectures
- 12V input (10-14V range)
- 0.75-5V0UT @10 Amps
- Non-isolated, fixed-frequency, synchronousrectifier topology
- Outstanding performance:
  - Efficiencies to 96.5% @ 10 Amps
  - · Low noise
  - · Stable no-load operation
  - · Adjustable output voltage
- Remote on/off control
- Sense pin on standard models
- Thermal shutdown
- No derating to +85°C with 100 lfm
- UL/IEC/EN60950 applied for
- EMC compliant
- Start up into pre-biased Load

# PRODUCT OVERVIEW

LSN D12 DC/DC's accept a 12V input (10-14V input range) and convert it, with the highest efficiency in the smallest space, to a 0.75 to 5 Volt output fully rated at 10 Amps. The output is user-adjustable by trim resistor or adjustment voltage.

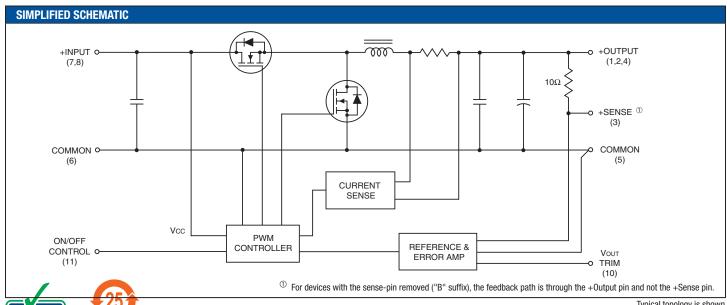
LSN D12's are ideal point-of-use/load power processors. They typically require no external components. Their vertical-mount packages occupy a mere 0.7 square inches (4.5 sq. cm), and reversed pin vertical mount allows mounting to meet competitor's keep out area. Horizontalmount packages ("H" suffix) are only 0.35 inches

The LSN's best-in-class power density is achieved with a fully synchronous, fixed-frequency, buck topology that also delivers: high efficiency (96.5%

for 5Vout models), low noise (35mVp-p typ.), tight line/load regulation, quick step response (50µsec), stable no-load operation, and no output reverse conduction.

The fully functional LSN's feature output overcurrent detection, continuous short-circuit protection, an output-voltage trim function, a remote on/off control pin, thermal shutdown and a sense pin. High efficiency enables, the LSN D12's to deliver rated output currents of 10 Amps at ambient temperatures to +85°C with natural convection.

If your new system boards call for three or more supply voltages, check out the economics of on-board 12V distributed power. If you don't need to pay for multiple isolation barriers, Datel nonisolated LSN D12 SIP's will save you money.



Typical topology is shown

For full details go to w.murata-ps.com/rohs



#### PERFORMANCE SPECIFICATIONS AND ORDERING GUIDE <sup>(1)</sup> Output Input **Efficiency** Package R/N (mVp-p) <sup>②</sup> Regulation (Max.) 3 **Full Load** VIN=10V IN 4 **V**out VIN Nom. Range (Case/ Typ. Max Line Load Model <sup>⑤</sup> (Volts) (Amps) (Volts) (Volts) (mA/A) Min Pinout) Tvp Typ. LSN-T/10-D12 0.7525-5.5 80/4.32 B5/B5x, P59 10 35 55 ±0.06% ±0.2% 12 10-14 95.5% 96.5% 97% LSN-T/10-D12J-Y 0.7525-5.5 35 ±0.06% 12 10-14 80/4.32 B5/B5x, P59 55 ±0.2% 95.5% 96.5% LSN-T/10-D12J-Y-CIS 0.7525-5.5 10 35 55 ±0.06% ±0.2% 12 10-14 80/4.32 95.5% 96.5% 97% B5/B5x, P59

Discontinued

To Be Discontinued

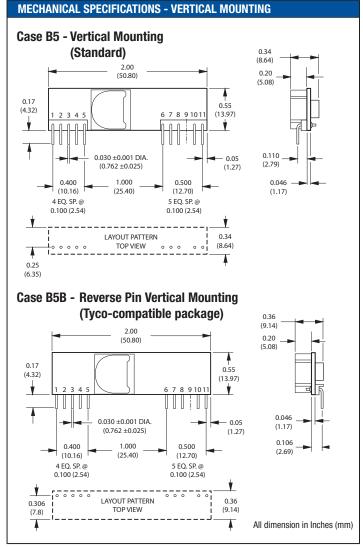
Typical at TA = +25°C under nominal line voltage, VouT = 5V, and full-load conditions, unless otherwise noted. All models are tested and specified with external 22µF tantalum input and output capacitors. These capacitors are necessary to accommodate our test equipment and may not be required to achieve specified performance in your applications. See I/O Filtering and Noise Reduction

#### \*LAST TIME BUY: 3/31/2017. CLICK HERE FOR DISCONTINUANCE NOTICES.

#### PART NUMBER STRUCTURE L SN - T /10- D12 N H J - C Output RoHS-6 Compliant **Configuration:** J Suffix: $\mathbf{L} = Unipolar$ Reversed Pin Low Voltage Vertical Mount Non-Isolated SIP **H Suffix: Nominal Output Voltage:** Horizontal Mount T = 0.75 - 5.25N Suffix: **Maximum Rated Output** On/Off Polarity: **Current in Amps** Blank = Positive logic N = Negative logic Note: **Input Voltage Range:** Not all model number combinations D12 = 10-14 Voltsare available. Contact Murata Power (12V nominal) Solutions.

#### **MECHANICAL SPECIFICATIONS - HORIZONTAL MOUNTING Case B5A - Horizontal Mounting** 0.35 (8.89) 2.00 0.21 (50.80) (5.33)0.05 ISOLATING PAD 0.55 (1.27)6 7 8 9 10 11 (13.97)2 3 4 5 ŧ. 0.16 0.030 ±0.001 DIA 0.05 (4.06 (1.27)0.360 0.400 1 000 0.500 (9.14)(12.70) (10.16)4 EQ. SP. @ 5 EQ. SP. @ 0.100 (2.54) 0.100 (2.54) 0.56 (13.46)0.55 0.50 (13.97)(12.7)LAYOUT PATTERN RECOMMENDED TOP VIEW COPPER PAD ON PCB (0.55 SQ. IN.) All dimension in Inches (mm)

- <sup>2</sup> Ripple/Noise (R/N) is tested/specified over a 20MHz bandwidth and may be reduced with external filtering. See I/O Filtering and Noise Reduction for details.
- 3 These devices have no minimum-load requirements and will regulate under no-load conditions. Regulation specifications describe the output-voltage deviation as the line voltage or load is varied from its nominal/midpoint value to either extreme.
- (4) Nominal line voltage, no-load/full-load conditions.
- This is not a complete model number. Please see the Part Number Structure when ordering.



I/O Connections									
Pin	Function P59	Pin	Function P59	Pin	Function P59				
1 +Output 5		Common	9	No Pin					
2	+Output	6	Common	10	Vout Trim				
3	+Sense	7	+Input	11	On/Off Control				
4	+Output	8	+Input						



# **Performance/Functional Specifications**

Typical @ $T_A = +25^{\circ}C$ under nominal line volt	age, voor=5v, and run-load conditions unless noted.				
Input					
Input Voltage Range	10-14 Volts (12V nominal)				
Input Current: Normal Operating Conditions Inrush Transient Standby/Off Mode Output Short-Circuit Condition	See Ordering Guide 0.02A <sup>2</sup> sec 5mA 60mA average				
Input Reflected Ripple Current ②	30mAp-p				
Input Filter Type	Capacitive				
Overvoltage Protection	None				
Reverse-Polarity Protection	None				
Start-up Voltage	9.2 Volts				
Undervoltage Shutdown	8 Volts				
On/Off Control ②③	On = Pin open to +VIN max.				
Positive Polarity (no suffix) Negative Polarity	Off = Zero (ground) to +0.8V max. On = Pin open or grounded to +0.3V Off = +2.5V to +Vin max.				
On/Off Current	0.5 mA maximum				
Output					
Maximum Output Power <sup>©</sup>	51 Watts				
Vout Accuracy (50% load)	±2%				
Minimum Loading <sup>①</sup>	No minimum load				
Maximum Capacitive Load	2,000μF (ESR < 0.02 0hms) 10,000μF (ESR > 0.02 0hms)				
Vout Trim Range <sup>② ⑥</sup>	+0.7525 to +5.5 Volts (no load)  See Ordering Guide  3% max. over line/load/temperature  See Ordering Guide				
Ripple/Noise (20MHz BW) ** (20					
Extreme Accuracy					
Efficiency <sup>②</sup>					
Pre-Bias Startup	Converter will start up if the external output voltage is less than Vsetpoint				
Overcurrent Detection and Short-Circ	cuit Protection: ②				
Current-Limit Inception Cold Condition Short-Circuit Detection Point	21 Amps 98% of Vout set				
SC Protection Technique Short-Circuit Current	Hiccup with auto recovery 400mA average				
SC Protection Technique	Hiccup with auto recovery				
SC Protection Technique Short-Circuit Current	Hiccup with auto recovery 400mA average				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics	Hiccup with auto recovery 400mA average				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ②	Hiccup with auto recovery 400mA average 50µsec to ±2% of final value				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ②  Vin to Vout and On/Off to Vout	Hiccup with auto recovery 400mA average 50µsec to ±2% of final value				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ②  Vin to Vout and On/Off to Vout  Switching Frequency:	Hiccup with auto recovery 400mA average 50µsec to ±2% of final value				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ② VIN to Vout and On/Off to Vout  Switching Frequency: Environmental	Hiccup with auto recovery 400mA average  50µsec to ±2% of final value  8msec 250 ±30 KHz				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ② Vin to Vour and On/Off to Vour  Switching Frequency:  Environmental  Calculated MTBF ⑤  Operating Temperature: (Ambient) ② Without Derating (Natural convection) With Derating  Storage Temperature	Hiccup with auto recovery 400mA average  50µsec to ±2% of final value  8msec 250 ±30 KHz  TBC  -40 to +85°C				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ② Vin to Vour and On/Off to Vour  Switching Frequency:  Environmental  Calculated MTBF ⑤  Operating Temperature: (Ambient) ② Without Derating (Natural convection) With Derating	Hiccup with auto recovery 400mA average  50µsec to ±2% of final value  8msec 250 ±30 KHz  TBC  -40 to +85°C See Derating Curves				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ② Vin to Vour and On/Off to Vour  Switching Frequency:  Environmental  Calculated MTBF ⑤  Operating Temperature: (Ambient) ② Without Derating (Natural convection) With Derating  Storage Temperature	Hiccup with auto recovery 400mA average  50µsec to ±2% of final value  8msec 250 ±30 KHz  TBC  -40 to +85°C See Derating Curves -40 to +125°C				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ② VIN to VOUT and On/Off to VOUT  Switching Frequency:  Environmental  Calculated MTBF ⑤  Operating Temperature: (Ambient) ② Without Derating (Natural convection) With Derating  Storage Temperature  Thermal Shutdown	Hiccup with auto recovery 400mA average  50µsec to ±2% of final value  8msec 250 ±30 KHz  TBC  -40 to +85°C See Derating Curves -40 to +125°C				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ② VIN to Vout and On/Off to Vout  Switching Frequency:  Environmental  Calculated MTBF ⑤  Operating Temperature: (Ambient) ② Without Derating (Natural convection) With Derating  Storage Temperature  Thermal Shutdown  Physical	Hiccup with auto recovery 400mA average  50µsec to ±2% of final value  8msec 250 ±30 KHz  TBC  1 -40 to +85°C See Derating Curves -40 to +125°C +115°C				
SC Protection Technique Short-Circuit Current  Dynamic Characteristics  Transient Response (50-100-50% load)  Start-Up Time: ② VM to Vout and On/Off to Vout  Switching Frequency:  Environmental  Calculated MTBF ⑤  Operating Temperature: (Ambient) ② Without Derating (Natural convection) With Derating  Storage Temperature  Thermal Shutdown  Physical  Dimensions	Hiccup with auto recovery 400mA average  50µsec to ±2% of final value  8msec 250 ±30 KHz  TBC  -40 to +85°C See Derating Curves -40 to +125°C +115°C  See Mechanical Specifications  0.03" (0.76mm) dia. round copper with tin plate over nickel underplate.				

Absolute Maximum Ratings	
Input Voltage: Continuous or transient	14 Volts
On/Off Control (Pin 11)	+Vin
Input Reverse-Polarity Protection	None
Output Overvoltage Protection	None
Output Current	Current limited. Devices can withstand sustained output short circuits without damage.
Storage Temperature	-40 to +125°C
Lead Temperature (soldering, 10 sec.)	+280°C
These are stress ratings. Exposure of devices	. 200

① All models are tested and specified with external 22µF tantalum input and 10 II 1µF output capacitors. These capacitors are necessary to accommodate our test equipment and may not be required to achieve specified performance in your applications. All models are stable and regulate within spec under no-load conditions.

affect long-term reliability. Proper operation under conditions other than those listed in

② See Technical Notes and Performance Curves for details.

the Performance/Functional Specifications Table is not implied.

- 3 The On/Off Control (pin 11) is designed to be driven with open-collector logic or the application of appropriate voltages (referenced to Common, pins 5 and 6).
- Output noise may be further reduced with the installation of additional external output filtering. See I/O Filtering and Noise Reduction.
- S MTBF's are calculated using Telcordia SR-332(Bellcore), ground fixed, TA = +25°C, full power, natural convection.
- © Do not exceed maximum rated output power when adjusting the output voltage.

#### **TECHNICAL NOTES**

# **Return Current Paths**

The LSN D12 SIP's are non-isolated DC/DC converters. Their two Common pins (pins 5 and 6) are connected to each other internally (see Figure 1). To the extent possible (with the intent of minimizing ground loops), input return current should be directed through pin 6 (also referred to as —Input or Input Return), and output return current should be directed through pin 5 (also referred to as —Output or Output Return). Any on/off control signals applied to pin 11 (On/Off Control) should be referenced to Common (specifically pin 6).

#### I/O Filtering and Noise Reduction

All models in the LSN D12 Series are tested and specified with external  $22\mu F$  tantalum input and 10 II  $1\mu F$  output capacitors. These capacitors are necessary to accommodate our test equipment and may not be required to achieve desired performance in your application. The LSN D12's are designed with high-quality, high-performance internal I/O caps, and will operate within spec in most applications with no additional external components.

In particular, the LSN D12's input capacitors are specified for low ESR and are fully rated to handle the units' input ripple currents. Similarly, the internal output capacitors are specified for low ESR and full-range frequency response.

In critical applications, input/output ripple/noise may be further reduced using filtering techniques, the simplest being the installation of external I/O caps.

External input capacitors serve primarily as energy-storage devices. They minimize high-frequency variations in input voltage (usually caused by IR drops in conductors leading to the DC/DC) as the switching converter draws pulses of current. Input capacitors should be selected for bulk capacitance (at appropriate frequencies), low ESR, and high rms-ripple-current ratings. The switching nature of modern DC/DC's requires that the dc input voltage source have low ac impedance at the frequencies of interest. Highly inductive source impedances can greatly affect system stability. Your specific system configuration may necessitate additional considerations.

Output ripple/noise (also referred to as periodic and random deviations or PARD) may be reduced below specified limits with the installation of additional external output capacitors. Output capacitors function as true filter elements and should be selected for bulk capacitance, low ESR, and appropriate frequency response. Any scope measurements of PARD should be made directly at the DC/DC output pins with scope probe ground less than 0.5" in length.

All external capacitors should have appropriate voltage ratings and be located as close to the converters as possible. Temperature variations for all relevant parameters should be taken into consideration.

The most effective combination of external I/O capacitors will be a function of your line voltage and source impedance, as well as your particular load and layout conditions. Our Applications Engineers can recommend potential solutions and discuss the possibility of our modifying a given device's internal filtering to meet your specific requirements. Contact our Applications Engineering Group for additional details.

#### **Input Fusing**

Most applications and or safety agencies require the installation of fuses at the inputs of power conversion components. LSN D12 Series DC/DC converters are not internally fused. Therefore, if input fusing is mandatory, either a normal-blow or a slow-blow fuse with a value no greater than 15 Amps

should be installed within the ungrounded input path to the converter.

As a rule of thumb however, we recommend to use a normal-blow or slowblow fuse with a typical value of about twice the maximum input current, calculated at low line with the converters minimum efficiency.

#### **Safety Considerations**

LSN D12 SIP's are non-isolated DC/DC converters. In general, all DC/DC's must be installed, including considerations for I/O voltages and spacing/separation requirements, in compliance with relevant safety-agency specifications (usually UL/IEC/EN60950).

In particular, for a non-isolated converter's output voltage to meet SELV (safety extra low voltage) requirements, its input must be SELV compliant. If the output needs to be ELV (extra low voltage), the input must be ELV.

## **Input Overvoltage and Reverse-Polarity Protection**

LSN D12 SIP Series DC/DC's do not incorporate either input overvoltage or input reverse-polarity protection. Input voltages in excess of the specified absolute maximum ratings and input polarity reversals of longer than "instantaneous" duration can cause permanent damage to these devices.

#### **Start-Up Time**

The VIN to Vout Start-Up Time is the interval between the time at which a ramping input voltage crosses the lower limit of the specified input voltage range and the fully loaded output voltage enters and remains within its specified accuracy band. Actual measured times will vary with input source impedance, external input capacitance, and the slew rate and final value of the input voltage as it appears to the converter.

The On/Off to Vour Start-Up Time assumes the converter is turned off via the On/Off Control with the nominal input voltage already applied to the converter. The specification defines the interval between the time at which the converter is turned on and the fully loaded output voltage enters and remains within its specified accuracy band. See Typical Performance Curves.

# **Installing the Converter**

These converters may be installed into either commercial pin sockets on 0.1" centers (similar to those used with through-hole integrated circuits) or inserted into plated-through holes on the host printed circuit board. Pin sockets obviously facilitate repair and replacement whereas PCB mounting is mechanically and electrically more secure. Soldered-down PCB installation also conducts more heat away from the converter. Consider increasing the copper etch area near the output pins.

Do not use excessive force when installing these converters. If you are not inserting the converter into pin sockets, make sure the holes on the host printed circuit board are of adequate size and spaced properly. You may bend the pins slightly to line them up with the PCB holes. Using two needle nose pliers, securely hold the base of the pin with one plier (where it enters the converter's PCB or the lead frame) and apply a very small bend with the other plier part way down the pin length. The two-plier method avoids excessive force on the converter's PCB. If pins are bent too far or too great an insertion force is used during installation, this may cause hidden damage on the converter, possibly voiding the warranty.

#### **Remote Sense**

LSN D12 SIP Series DC/DC converters offer an output sense function on pin 3.

The sense function enables point-of-use regulation for overcoming moderate IR drops in conductors and/or cabling. Since these are non-isolated devices whose inputs and outputs usually share the same ground plane, sense is provided only for the +Output.

The remote sense line is part of the feedback control loop regulating the DC/DC converter's output. The sense line carries very little current and consequently requires a minimal cross-sectional-area conductor. As such, it is not a low-impedance point and must be treated with care in layout and cabling. Sense lines should be run adjacent to signals (preferably ground), and in cable and/or discrete-wiring applications, twisted-pair or similar techniques should be used. To prevent high frequency voltage differences between Vout and Sense, we recommend installation of a 1000pF capacitor close to the converter.

The sense function is capable of compensating for voltage drops between the +Output and +Sense pins that do not exceed 10% of  $V_{0UT}$ .

$$[Vout(+) - Common] - [Sense(+) - Common] \le 10\%Vout$$

Power derating (output current limiting) is based upon maximum output current and voltage at the converter's output pins. Use of trim and sense functions can cause the output voltage to increase, thereby increasing output power beyond the LSN's specified rating. Therefore:

The internal  $10\Omega$  resistor between +Sense and +Output (see Figure 1) serves to protect the sense function by limiting the output current flowing through the sense line if the main output is disconnected. It also prevents output voltage runaway if the sense connection is disconnected.

Note: Connect the +Sense pin (pin 3) to +Output (pin 4) at the DC/DC converter pins, if the sense function is not used for remote regulation.

# **On/Off Control**

The On/Off Control pin may be used for remote on/off operation. LSN-T/10-D12 SIP is designed so they are enabled when the control pin is left open (internal pull-down to Common) and disabled when the control pin is pulled high, as shown in Figure 2 and 2a.

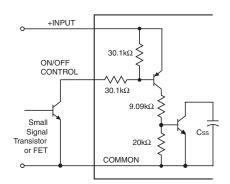


Figure 2. Driving the On/Off Control Pin with an Open-Collector Drive Circuit

Dynamic control of the on/off function is best accomplished with a mechanical relay or open-collector/open-drain drive circuit. The drive circuit should be able to sink appropriate current when activated and withstand appropriate voltage when deactivated. The on/off control function, however, can be externally inverted so that the converter will be disabled while the input voltage is ramping up and then "released" once the input has stabilized.

LSN D12 SIP Series DC/DC converters do not incorporate output overvoltage protection. In the extremely rare situation in which the device's feedback loop is broken, the output voltage may run to excessively high levels (Vout = Vin). If it is absolutely imperative that you protect your load against any and all possible overvoltage situations, voltage limiting circuitry must be provided external to the power converter.

## **Output Overcurrent Detection**

Overloading the output of a power converter for an extended period of time will invariably cause internal component temperatures to exceed their maximum ratings and eventually lead to component failure. High-current-carrying components such as inductors, FET's and diodes are at the highest risk. LSN D12 SIP Series DC/DC converters incorporate an output overcurrent detection and shutdown function that serves to protect both the power converter and its load.

If the output current exceeds it maximum rating by typically 70% or if the output voltage drops to less than 98% of it's original value, the LSN D12's internal overcurrent-detection circuitry immediately turns off the converter, which then goes into a "hiccup" mode. While hiccupping, the converter will continuously attempt to restart itself, go into overcurrent, and then shut down. Under these conditions, the average output current will be approximately 400mA. Once the output short is removed, the converter will automatically restart itself.

#### **Thermal Performance**

The typical output-current thermal-derating curves shown below enable designers to determine how much current they can reliably derive from each model of the LSN D12 SIP's under known ambient-temperature and air-flow conditions. Similarly, the curves indicate how much air flow is required to reliably deliver a specific output current at known temperatures.

The highest temperatures in LSN D12 SIP's occur at their output inductor, whose heat is generated primarily by I²R losses. The derating curves were developed using thermocouples to monitor the inductor temperature and varying the load to keep that temperature below +110°C under the assorted conditions of air flow and air temperature. Once the temperature exceeds +115°C (approx.), the thermal protection will disable the converter. Automatic restart occurs after the temperature has dropped below +110°C.

Lastly, when LSN D12 SIP's are installed in system boards, they are obviously subject to numerous factors and tolerances not taken into account here. If you are attempting to extract the most current out of these units under demanding temperature conditions, we advise you to monitor the output-inductor temperature to ensure it remains below +110°C at all times.

#### Thermal Performance for "H" Models

Enhanced thermal performance can be achieved when LSN D12 SIP's are mounted horizontally ("H" models) and the output inductor (with its electrically isolating, thermally conductive pad installed) is thermally coupled to a copper plane/pad (at least 0.55 square inches in area) on the system board. Your conditions may vary, however our tests indicate this configuration delivers a 16°C to 22°C improvement in ambient operating temperatures.

#### **Pre-Biased Startup**

Newer systems with multiple power voltages have an additional problem besides startup sequencing. Some sections have power already partially applied (possibly because of earlier power sequencing) or have leakage power present so that the DC/DC converter must power up into an existing voltage. This power may either be stored in an external bypass capacitor or supplied by an active source.

This "pre-biased" condition can also occur with some types of program-mable logic or because of blocking diode leakage or small currents passed through forward biased ESD diodes. Conventional DC/DC's may fail to start up correctly if there is output voltage already present. And some external circuits are adversely affected when the low side MOSFET in a synchronous rectifier converter sinks current at start up.

The LSN2 series includes a pre-bias startup mode to prevent these initialization problems. Essentially, the converter acts as a simple buck converter until the output reaches its set point voltage at which time it converts to a synchronous rectifier design. This feature is variously called "monotonic" because the voltage does not decay (from low side MOSFET shorting) or produce a negative transient once the input power is applied and the startup sequence begins.

# **Output Adjustments**

The LSN-T/10-D12J includes an output adjustment and trimming function which is fully compatible with competitive units. The output voltage may be varied using a single trim resistor from the Trim input to Power Common or an external DC trim voltage applied between the Trim input and Power Common.

For resistor trim adjustments, be sure to use a precision low-tempco resistor  $(\pm 100 \text{ ppm/}^{\circ}\text{C})$  mounted close to the converter with short leads. Since the output accuracy is  $\pm 2\%$  (typical), you may need to vary this resistance slightly.

For adjustments using an external voltage reference, the equivalent input impedance looking in to the Trim input is approximately 5,000 Ohms. Therefore you may have to compensate for this in the source resistance of your external reference. Although filtered internally, the Trim input is sensitive and therefore susceptible to noise pickup with longer leads. Consider adding a small bypass capacitor,  $0.1\mu F$  or larger mounted adjacent to the converter between the Trim and Power Common if there is noise in the application.

The Trim input voltage range is offset against the 0.7 Volt reference of the PWM. Also note that the Trim input is inverting (lower trim voltage produces higher output voltage and vice versa). Do not exceed the voltage range or maximum power rating.

#### **D12 Models Resistor Trim Equation:**

Rtrim 
$$(\Omega) = \frac{10500}{\text{Vo} - 0.7525} - 1000$$

where Vo is the desired output voltage.

<b>V</b> out	0.7525V	1.0V	1.2V	1.5V	1.8V	2V	2.5V	3.3V	5V
RTRIM (kΩ)	Open	41.424	22.46	13.05	9.024	7.417	5.009	3.122	1.472

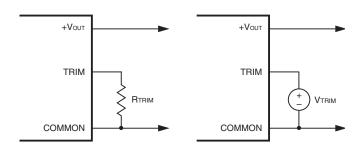
# **D12 Models Voltage Trim Equation:**

VTRIM (in Volts) = 
$$0.7 - (0.0667 \text{ x (V}_0 - 0.7525))$$

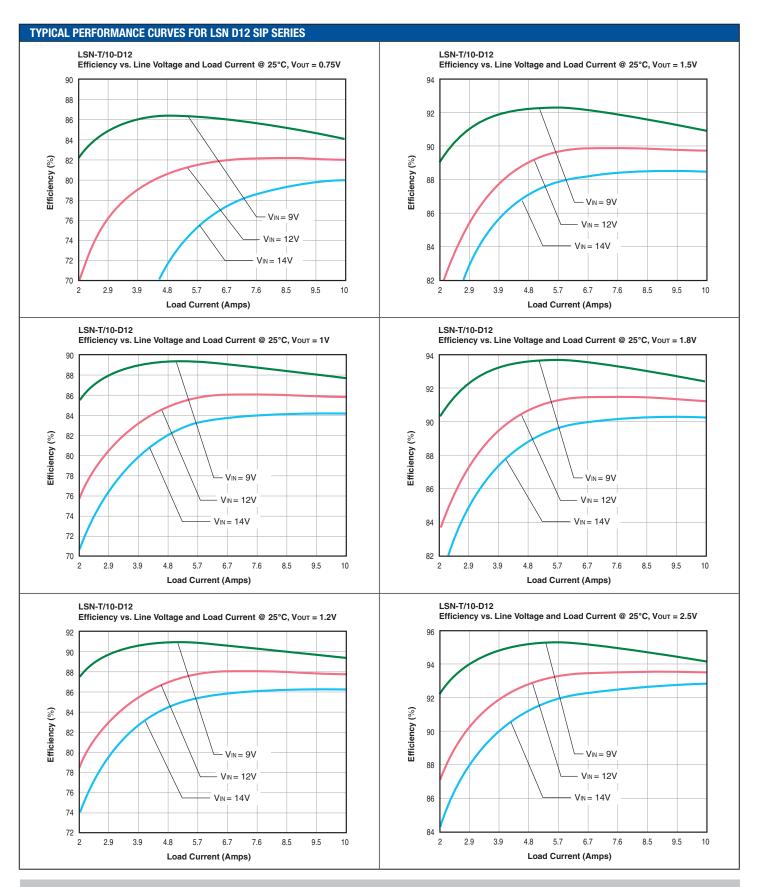
where Vo is the desired output voltage.

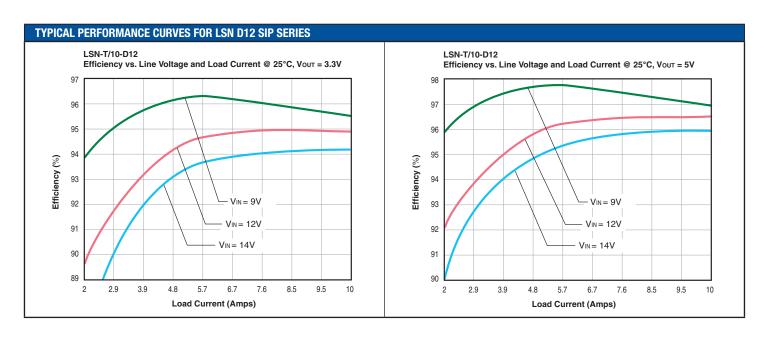
The D12 fixed trim voltages to set the output voltage are:

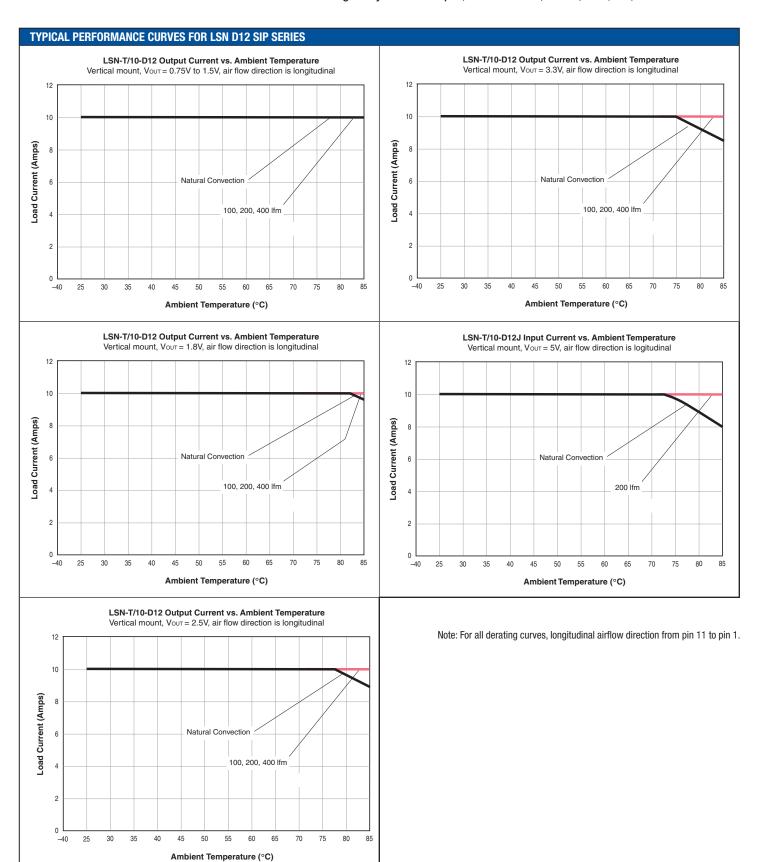
	<b>V</b> out	0.7525V	1.0V	1.2V	1.5V	1.8V	2V	2.5V	3.3V	5V
,	VTRIM (V)	Open	0.6835	0.670	0.650	0.630	0.617	0.583	0.530	0.4166

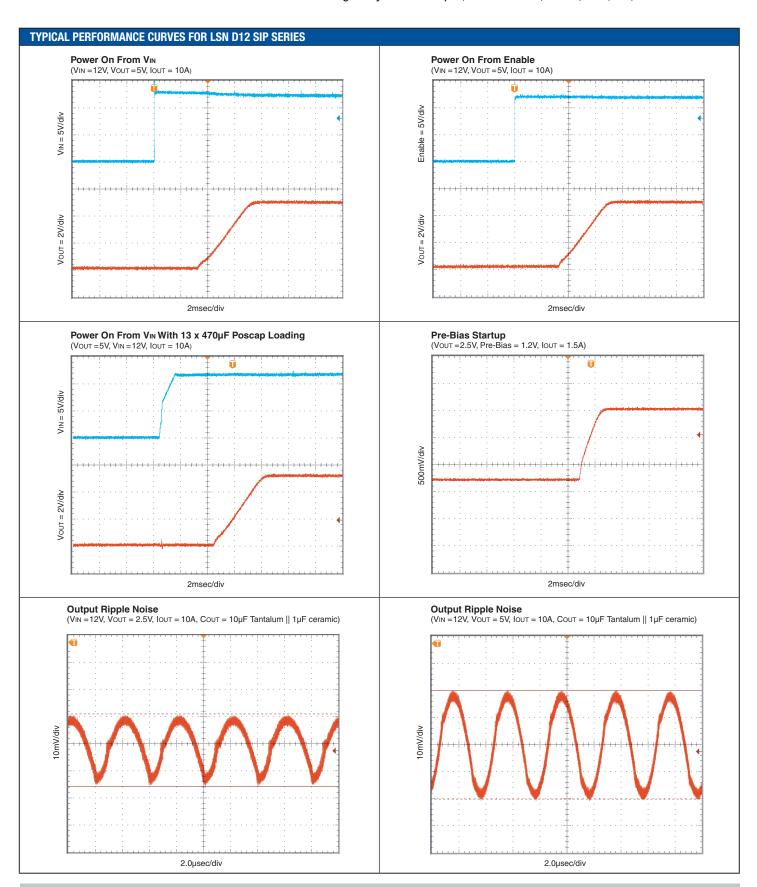


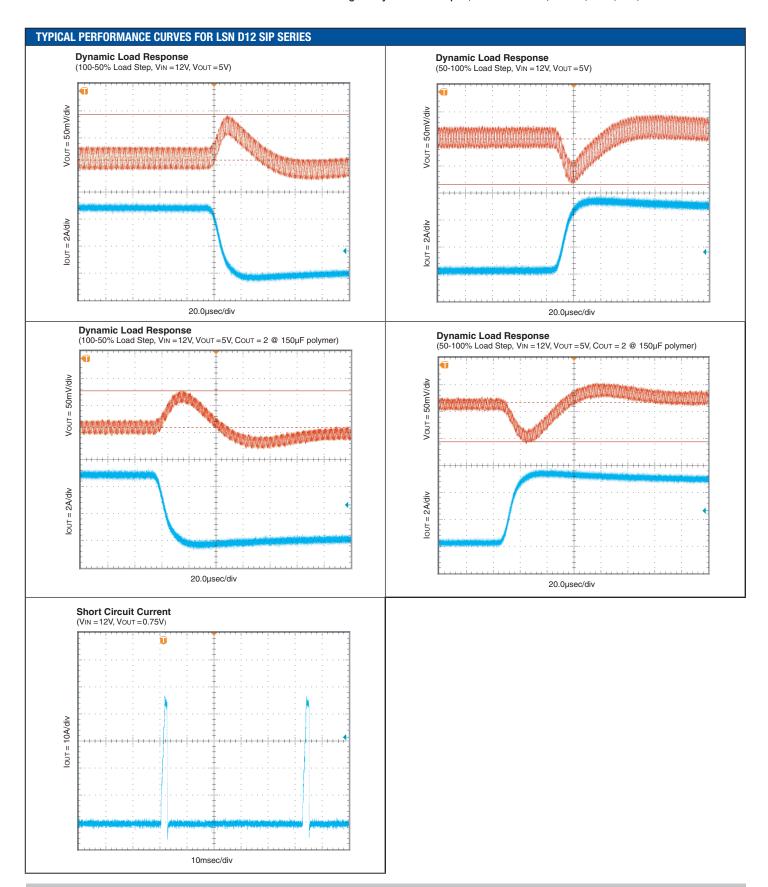
**Trim Connections** 















Murata Power Solutions, Inc.
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This product is subject to the following operating requirements and the Life and Safety Critical Application Sales Policy:

Refer to: <a href="http://www.murata-ps.com/requirements/">http://www.murata-ps.com/requirements/</a>

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